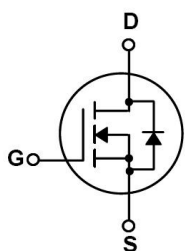


/ Descriptions

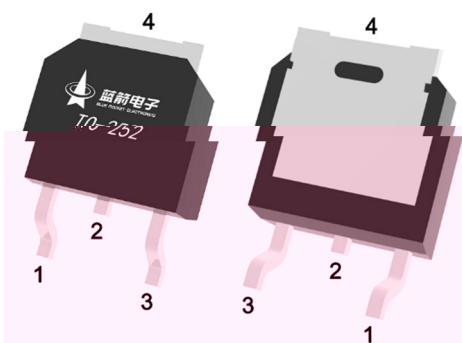
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

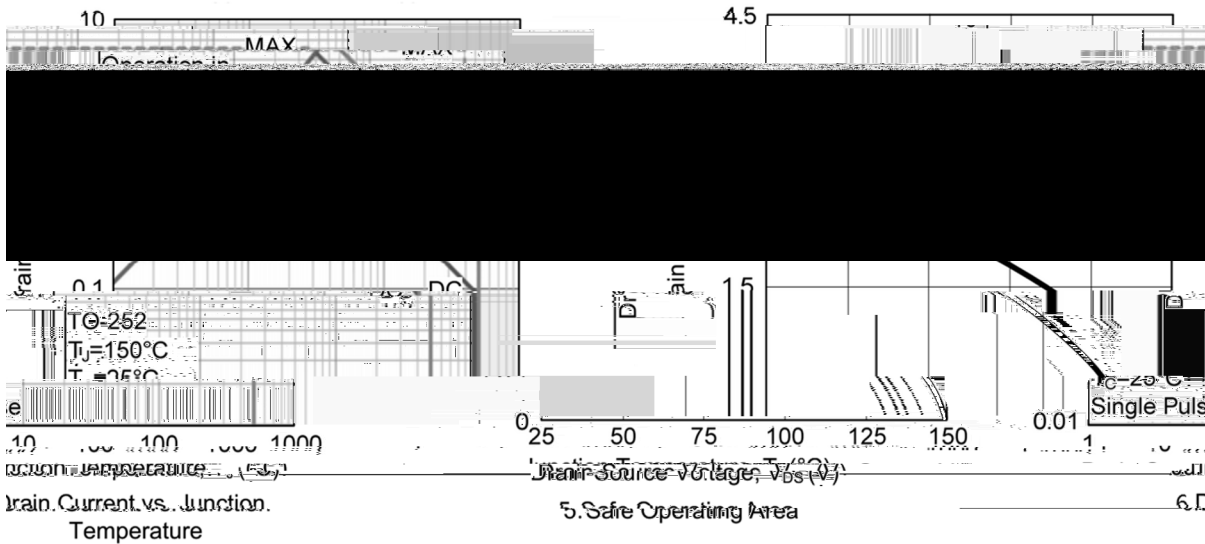
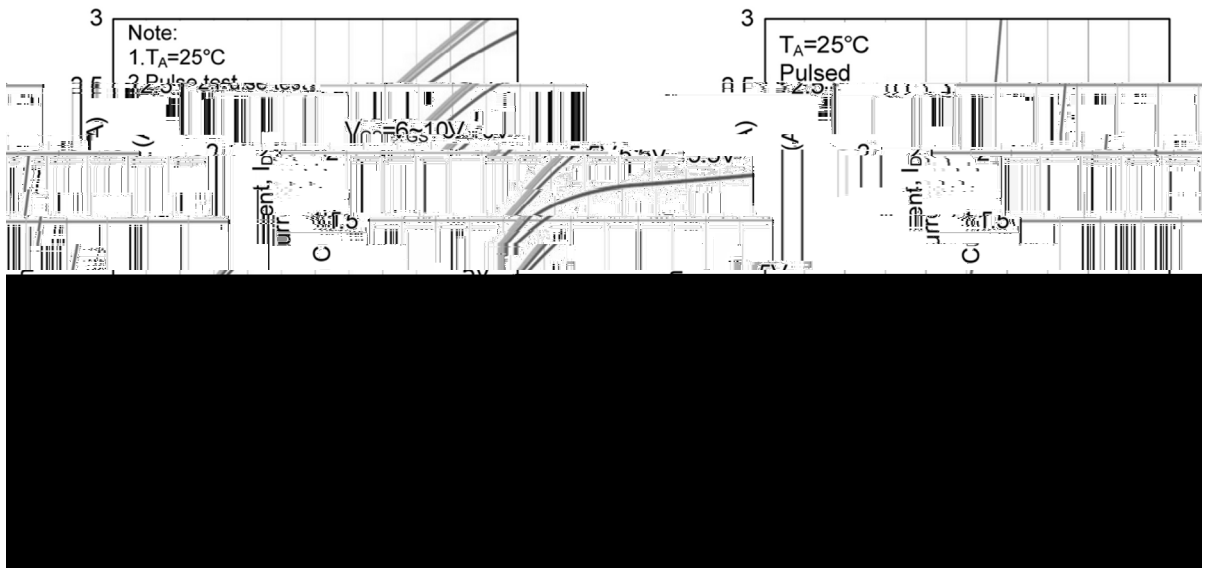
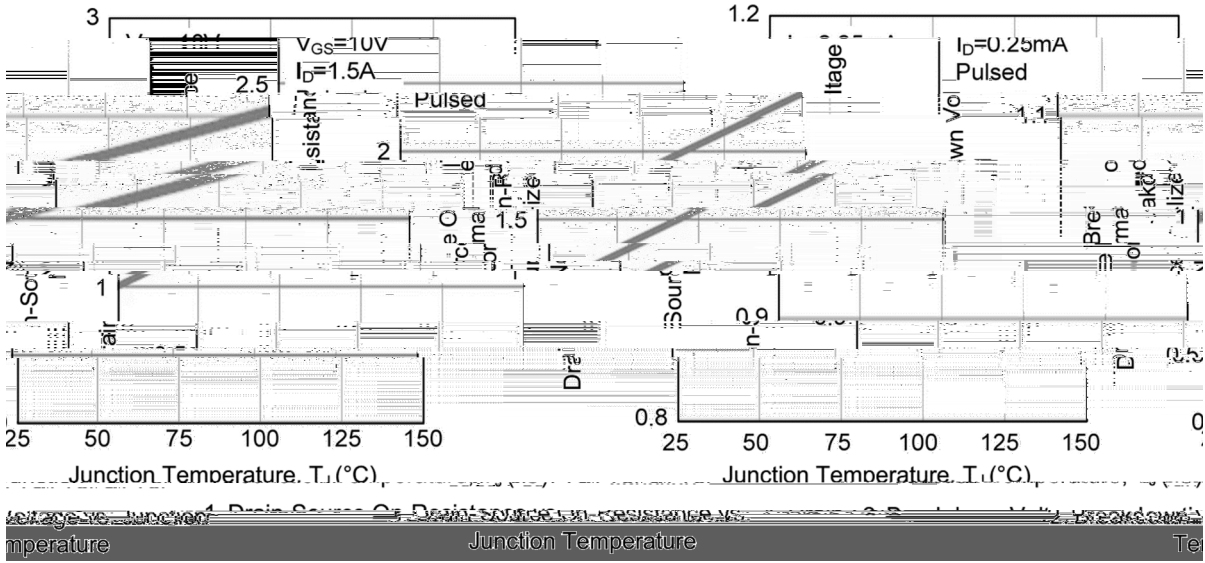


/ Marking

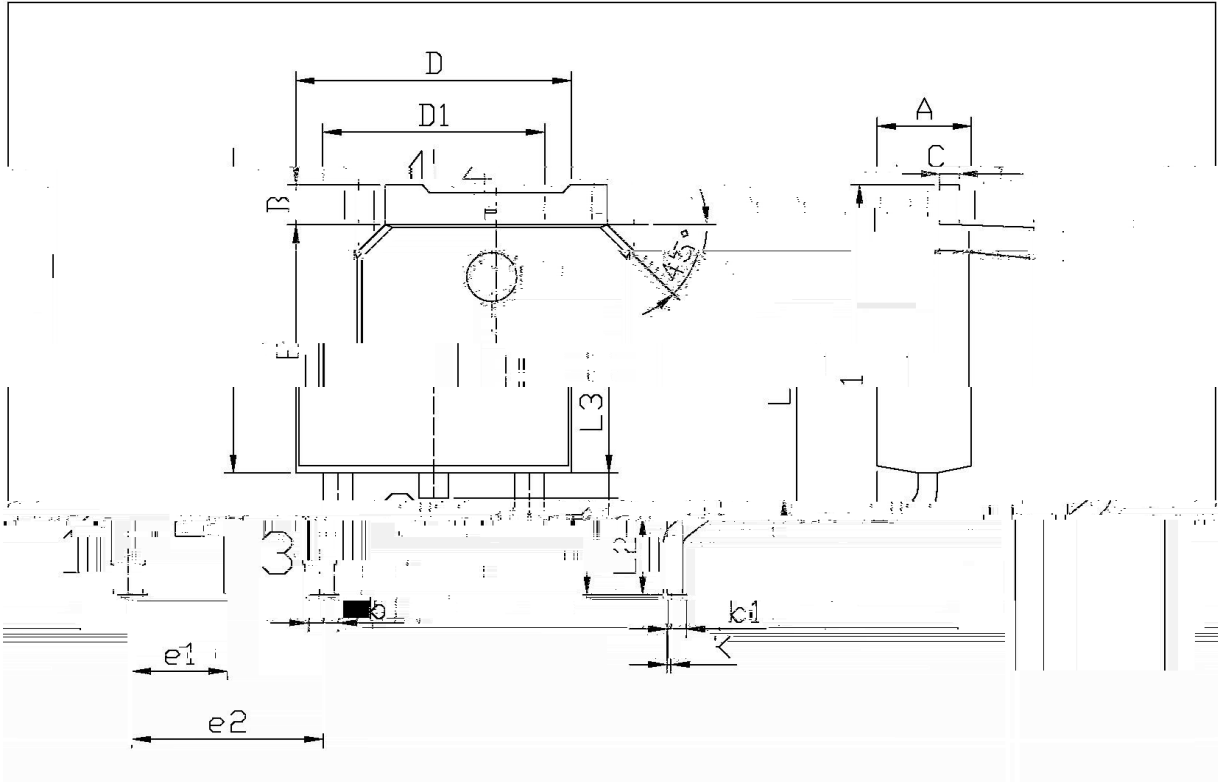
BRD3N50

/ Electrical Characteristics(Ta=25)

/ Electrical Characteristic Curve



/ Package Dimensions

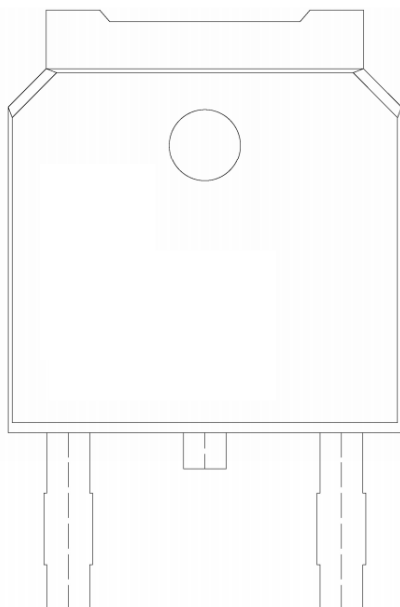


单位: mm

Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min.	Max.		Min.	Max.
A	2.20	2.40	E	5.50	5.80
B	0.95	1.25	e1	2.70	3.00
C	0.70	0.80	e2	4.40	4.70
D	6.45	6.75	L3	0.50	0.60
D1	6.45	6.75	k1	0.50	0.60
E	5.50	5.80			
e1	2.70	3.00			
e2	4.40	4.70			
L3	0.50	0.60			
k1	0.50	0.60			

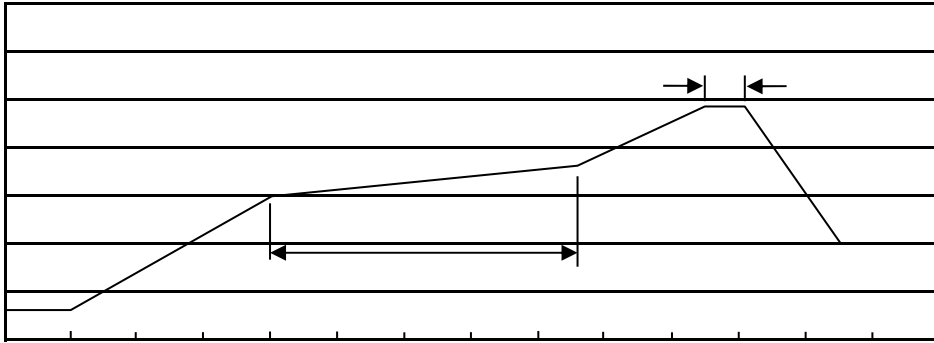
TO-252

/ Marking Instructions



3N50

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

/ Notices